

AN7512

Dual 1-W BTL audio power amplifier

■ Overview

The AN7512 is an audio power amplifier IC for stereo system. The BTL (Balanced Transformer-Less) method can provide fewer external parts and more easy design for applications.

■ Features

- 1-W output (8 Ω) with supply voltage of 5 V
- On-chip standby function
- On-chip volume function

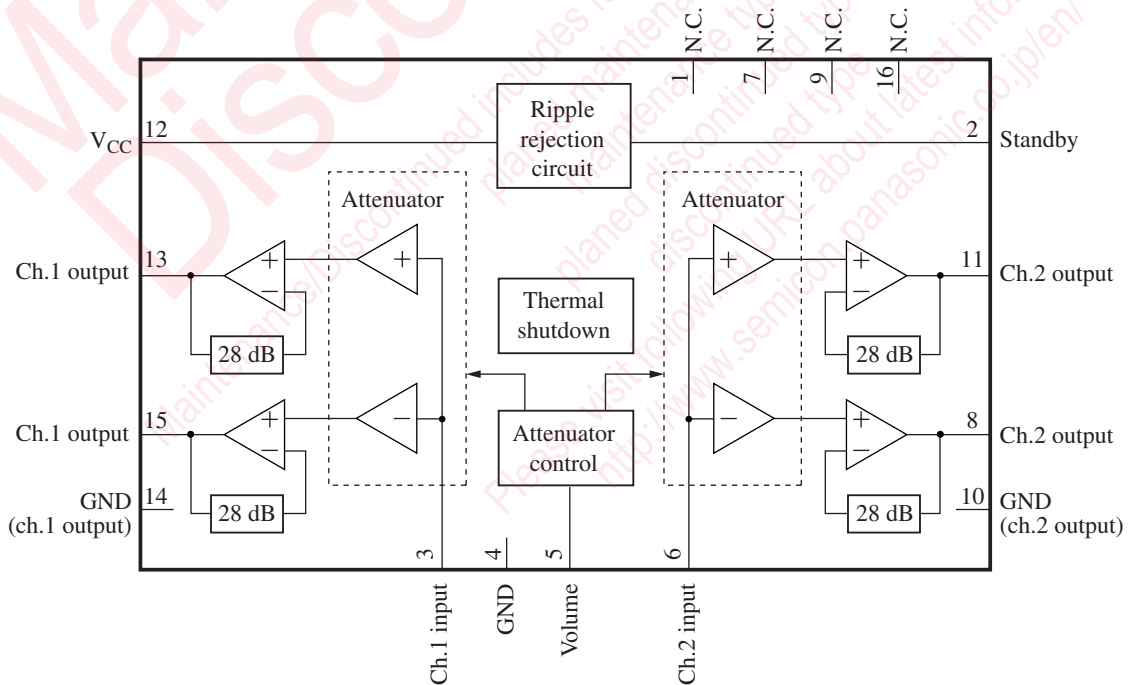
■ Applications

- Televisions, audio equipment, personal computers, and active speakers

■ Package

- HDIP016-P-300A

■ Block Diagram



■ Pin Descriptions

Pin No.	Description	Pin No.	Description
1	N.C.	9	N.C.
2	Standby (standby state if this pin is open.)	10	Ground (output ch.2)
3	Ch.1 input	11	Ch.2 + output
4	Ground (input)	12	Supply voltage
5	Volume (muting off if this pin is open.)	13	Ch.1 + output
6	Ch.2 input	14	Ground (output ch.1)
7	N.C.	15	Ch.1 – output
8	Ch.2 – output	16	N.C.

Note) Please do not apply voltage or current to the N.C. pin from outside.

■ Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
Supply voltage ^{*2}	V_{CC}	14	V
Supply current	I_{CC}	2.0	A
Power dissipation ^{*3}	P_D	1 127	mW
Operating ambient temperature ^{*1}	T_{opr}	-25 to +70	°C
Storage temperature ^{*1}	T_{stg}	-55 to +150	°C

Note) *1: Except for the operating ambient temperature and storage temperature, all ratings are for $T_a = 25^\circ\text{C}$.

*2: At no signal.

*3: The power dissipation shown is the value for $T_a = 70^\circ\text{C}$.

■ Recommended Operating Range

Parameter	Symbol	Range	Unit
Supply voltage	V_{CC}	3.5 to 13.5	V

■ Electrical Characteristics at $V_{CC} = 5.0\text{ V}$, $R_L = 8\ \Omega$, $f = 1\text{ kHz}$, $T_a = 25^\circ\text{C} \pm 2^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Quiescent circuit current	I_{CQ}	$V_{IN} = 0\text{ mV}$, $\text{Vol.} = 0\text{ V}$	—	35	100	mA
Standby current	I_{STB}	$V_{IN} = 0\text{ mV}$, $\text{Vol.} = 0\text{ V}$	—	1	10	μA
Output noise voltage *	V_{NO}	$R_g = 10\text{ k}\Omega$, $\text{Vol.} = 0\text{ V}$	—	0.10	0.4	mV[rms]
Voltage gain	G_V	$P_O = 0.25\text{ W}$, $\text{Vol.} = 1.25\text{ V}$	31	33	35	dB
Total harmonics distortion	THD	$P_O = 0.25\text{ W}$, $\text{Vol.} = 1.25\text{ V}$	—	0.10	0.5	%
Maximum output power	P_{O1}	THD = 10 %, $\text{Vol.} = 1.25\text{ V}$	0.7	1.0	—	W
Ripple rejection ratio *	RR	$R_g = 10\text{ k}\Omega$, $\text{Vol.} = 0\text{ V}$, $V_R = 0.5\text{ V[rms]}$, $f_R = 120\text{ Hz}$	30	50	—	dB
Output offset voltage	V_{OFF}	$R_g = 10\text{ k}\Omega$, $\text{Vol.} = 0\text{ V}$	-250	0	250	mV
Volume attenuation rate *	Att	$P_O = 0.25\text{ W}$, $\text{Vol.} = 0\text{ V}$	70	85	—	dB
Channel balance 1	CB1	$P_O = 0.25\text{ W}$, $\text{Vol.} = 1.25\text{ V}$	-1	0	1	dB
Channel balance 2	CB2	$P_O = 0.25\text{ W}$, $\text{Vol.} = 0.6\text{ V}$	-3	0	3	dB
Intermediate voltage gain	G_{VM}	$P_O = 0.25\text{ W}$, $\text{Vol.} = 0.6\text{ V}$	20.5	23.5	26.5	dB
Channel crosstalk	CT	$P_O = 0.25\text{ W}$, $\text{Vol.} = 1.25\text{ V}$	40	55	—	dB

Note) *: In measuring, the filter for the range of 15 Hz to 30 kHz (12 dB/OCT) is used.

■ Terminal Equivalent Circuits

Pin No.	Pin name	Equivalent circuit	Voltage
1	N.C.	Open	—
2	Standby pin		5 V

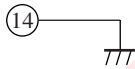
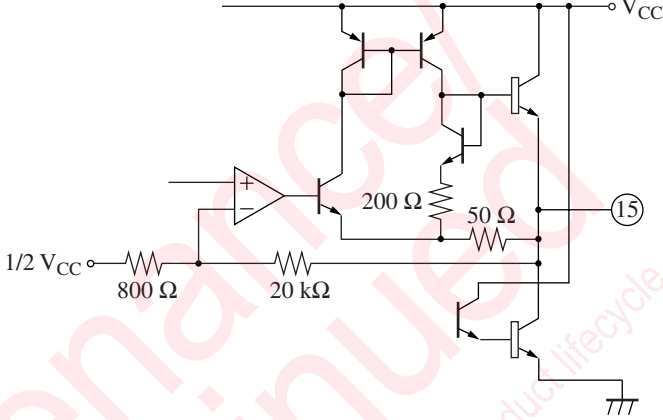
■ Terminal Equivalent Circuits (continued)

Pin No.	Pin name	Equivalent circuit	Voltage
3	Ch.1 input pin		1.4 V
4	GND		0 V
5	Volume pin		—
6	Ch.2 input pin		1.4 V
7	N.C.	Open	—

■ Terminal Equivalent Circuits (continued)

Pin No.	Pin name	Equivalent circuit	Voltage
8	Ch.2 - output pin		2.15 V
9	N.C.	Open	—
10	GND		0 V
11	Ch.2 + output pin		2.15 V
12	V _{CC}	—	5.0 V
13	Ch.1 + output pin		2.15 V

■ Terminal Equivalent Circuits (continued)

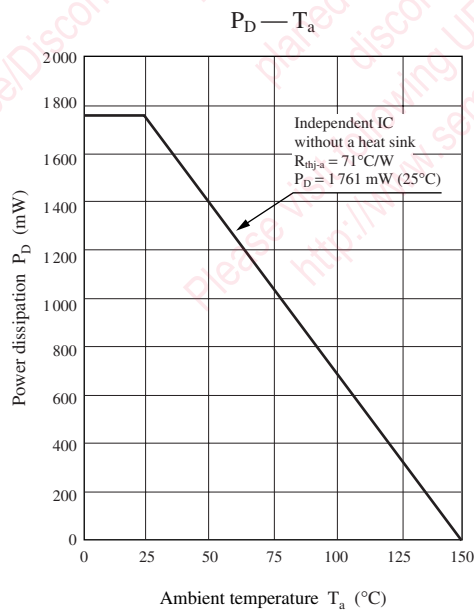
Pin No.	Pin name	Equivalent circuit	Voltage
14	GND		0 V
15	Ch.1 – output pin		2.15 V
16	N.C.	Open	—

■ Usage Notes

- Please avoid the short circuit to V_{CC} , ground, or load short circuit.
- Please connect the cooling fin with the GND potential.
- The thermal shutdown circuit operates at about $T_j = 150^\circ\text{C}$. However, the thermal shutdown circuit is reset automatically if the temperature drops.
- Please carefully design the heat radiation especially when you take out high power at high V_{CC} .
- Please connect only the ground of signal with the signal GND of the amplifier in the previous stage.

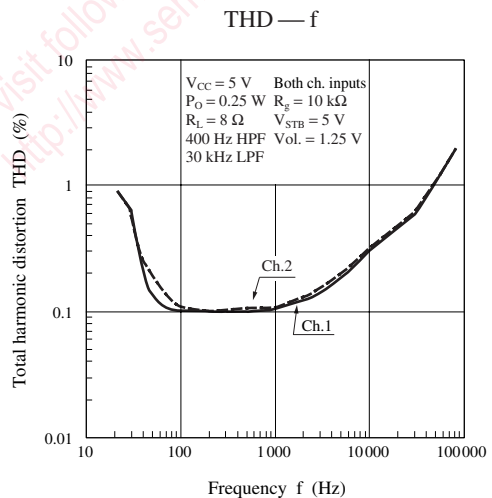
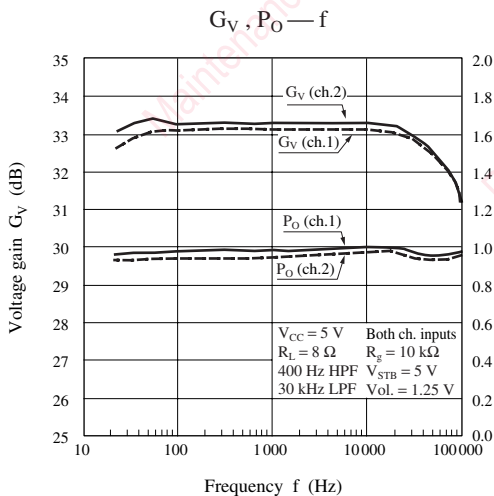
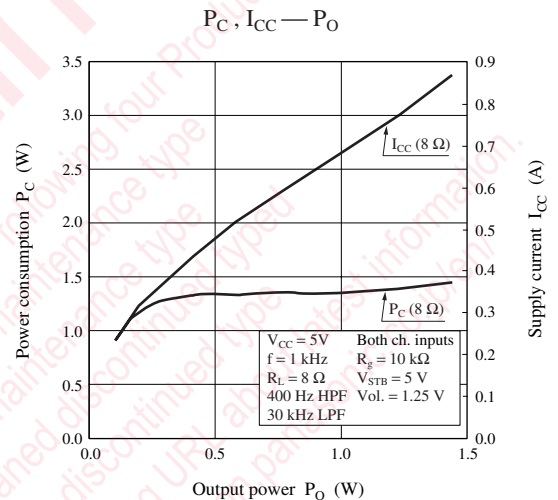
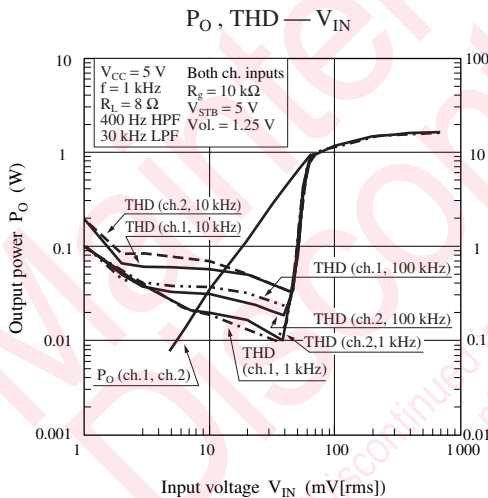
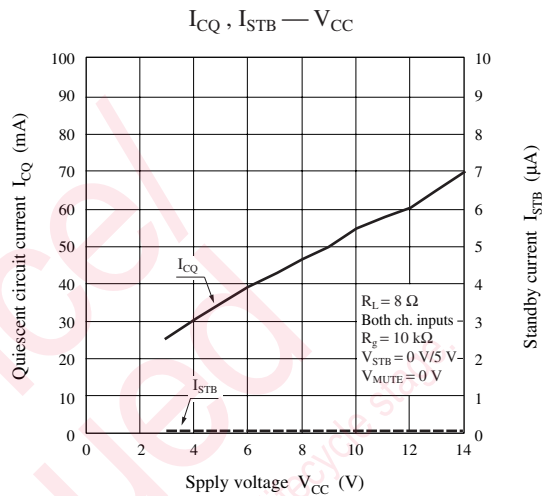
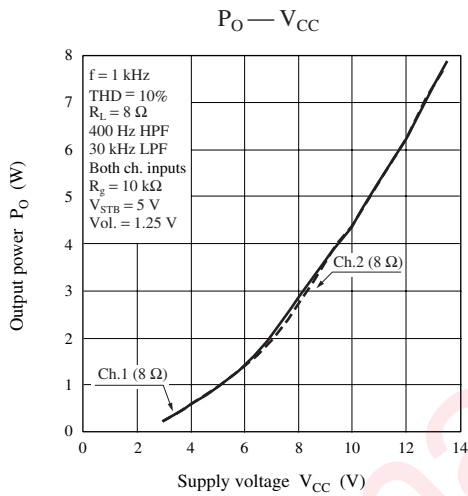
■ Technical Data

- $P_D - T_a$ curve of HDIP016-P-0300



■ Technical Data (continued)

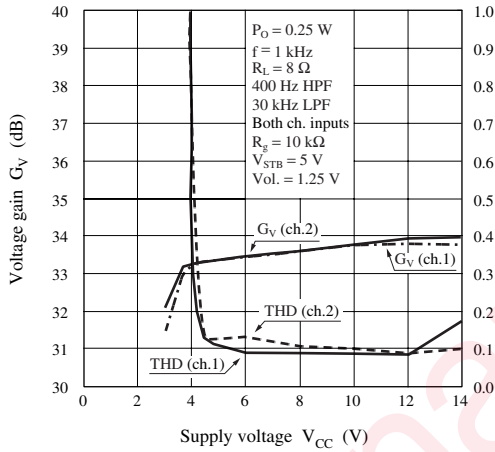
• Main characteristics



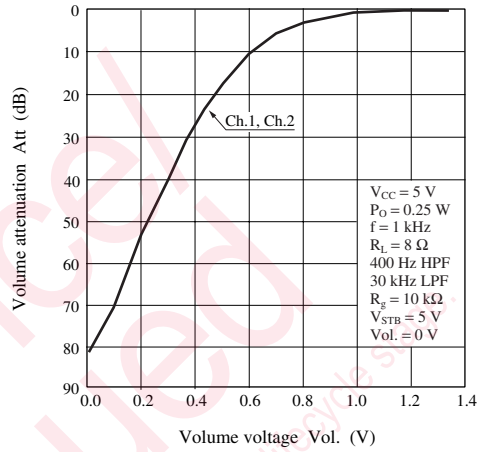
■ Technical Data (continued)

● Main characteristics (continued)

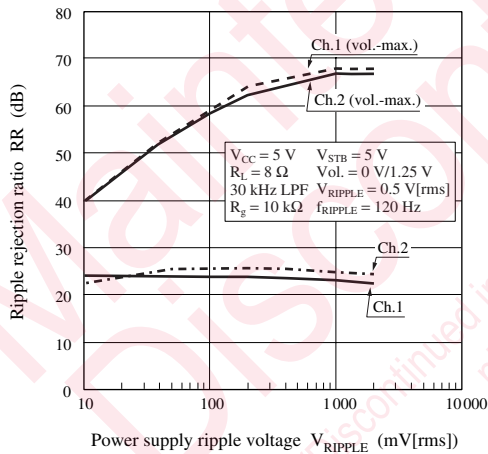
G_V , THD — V_{CC}



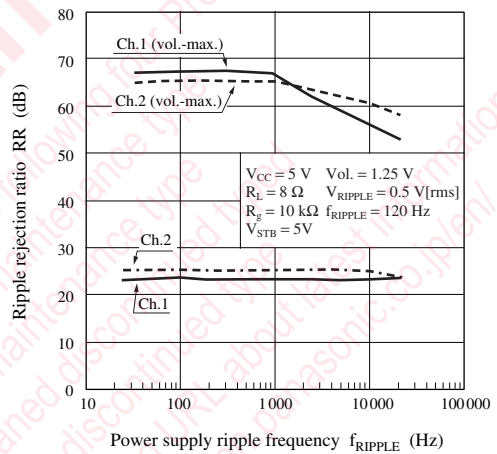
Att — Vol.



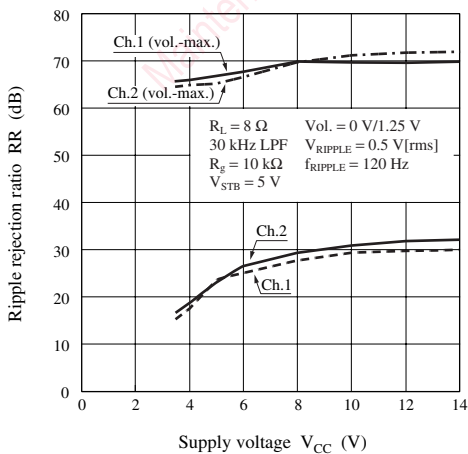
RR — V_{RIPPLE}



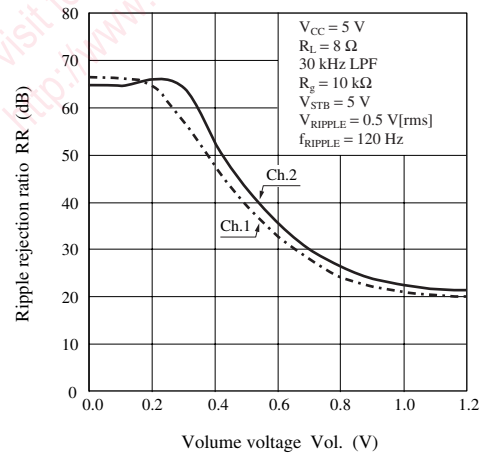
RR — f_{RIPPLE}



RR — V_{CC}



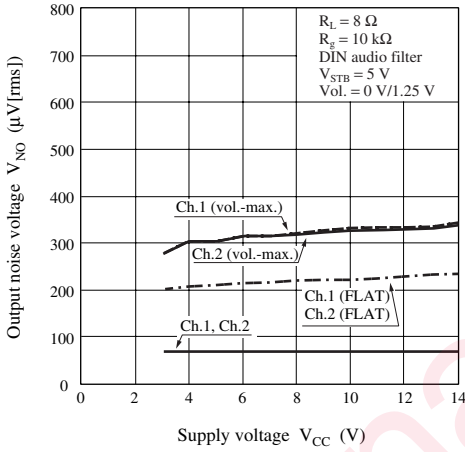
RR — Vol.



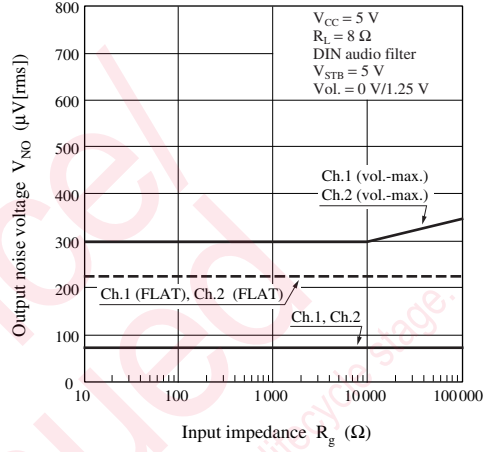
■ Technical Data (continued)

• Main characteristics (continued)

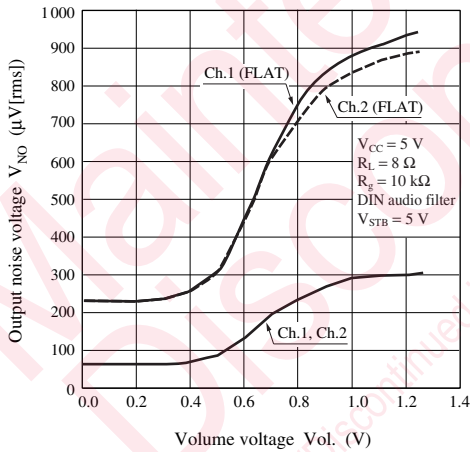
$V_{NO} - V_{CC}$



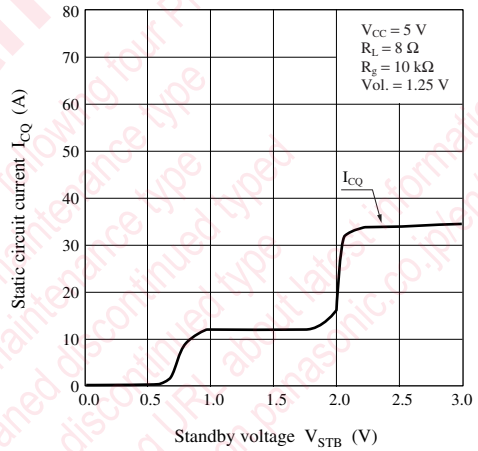
$V_{NO} - R_g$



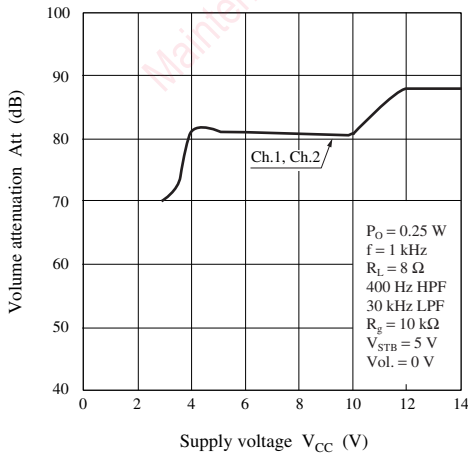
$V_{NO} - Vol.$



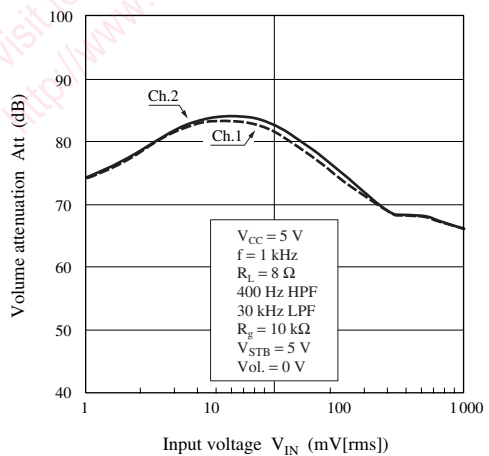
$I_{CQ} - V_{STB}$



Att — V_{CC}



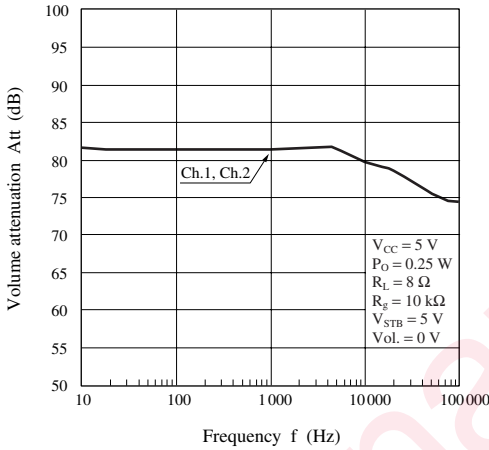
Att — V_{IN}



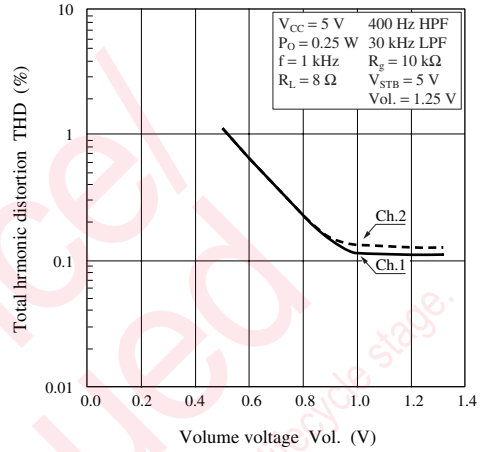
■ Technical Data (continued)

● Main characteristics (continued)

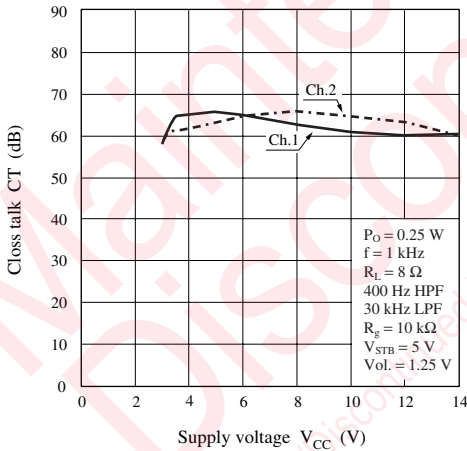
Att — f



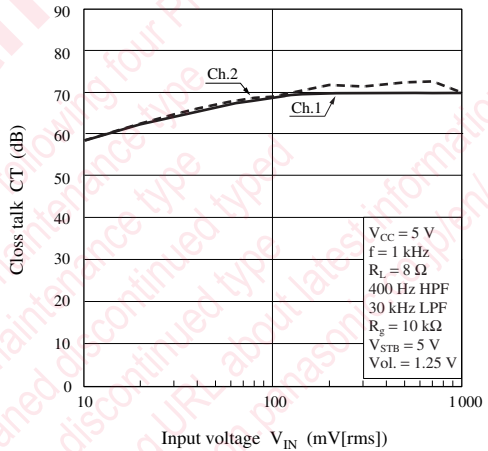
THD — Vol.



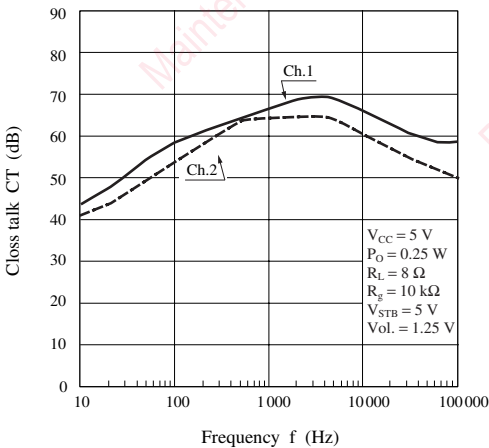
CT — V_{CC}



CT — V_{IN}

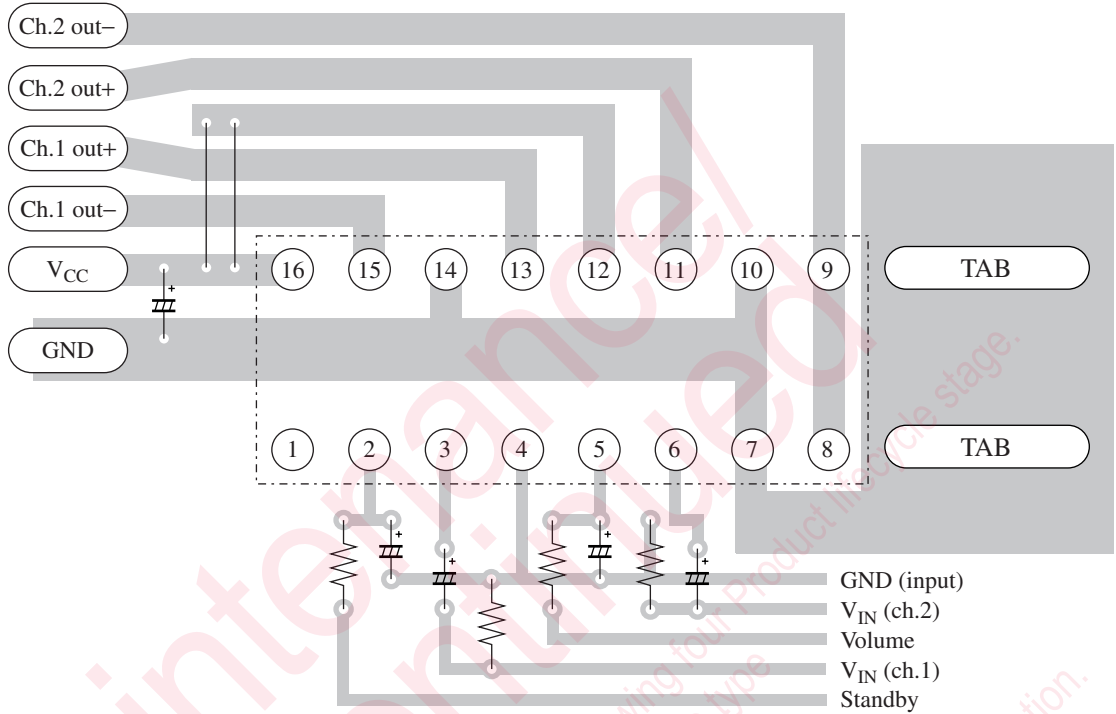


CT — f

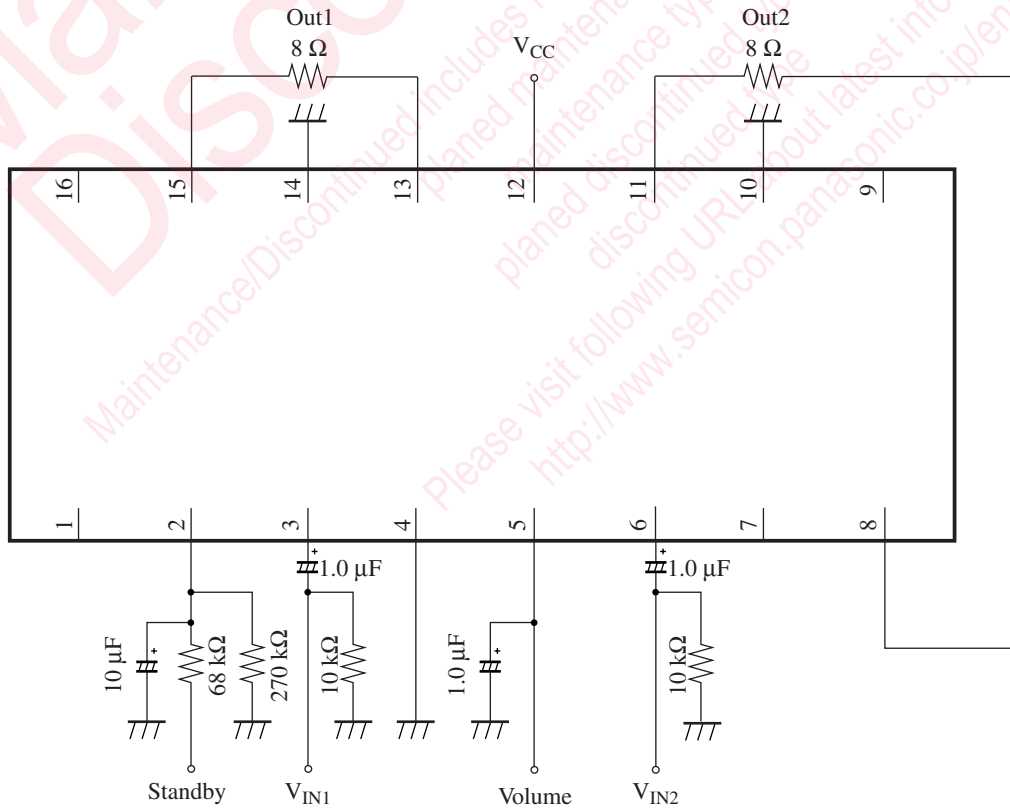


■ Technical Data (continued)

• Example of PCB pattern



■ Application Circuit Example



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